

# MOS FIELD EFFECT TRANSISTOR 2SK2140, 2SK2140-Z

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

### DESCRIPTION

The 2SK2140, 2SK2140-Z is N-channel Power MOS Field Effect Transistor designed for high voltage switching applications.

### FEATURES

- Low On-state Resistance  
 $R_{DS(on)} = 1.5 \Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 3.5 \text{ A)}$
- Low  $C_{iss}$   $C_{iss} = 930 \text{ pF TYP.}$
- High Avalanche Capability Ratings

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25 \text{ }^\circ\text{C}$ )

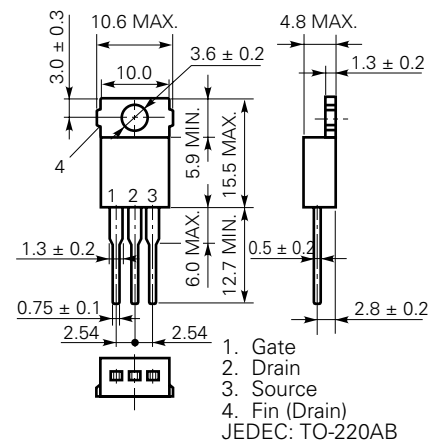
Drain to Source Voltage	$V_{DSS}$	600	V
Gate to Source Voltage	$V_{GSS}$	$\pm 30$	V
Drain Current (DC)	$I_{D(DC)}$	$\pm 7.0$	A
Drain Current (pulse)*	$I_{D(pulse)}$	$\pm 28$	A
Total Power Dissipation ( $T_c = 25 \text{ }^\circ\text{C}$ )	$P_{T1}$	75	W
Total Power Dissipation ( $T_A = 25 \text{ }^\circ\text{C}$ )	$P_{T2}$	1.5	W
Storage Temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$
Channel Temperature	$T_{ch}$	150	$^\circ\text{C}$
Single Avalanche Current**	$I_{AS}$	7.0	A
Single Avalanche Energy**	$E_{AS}$	16.3	mJ

\*  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1 \%$

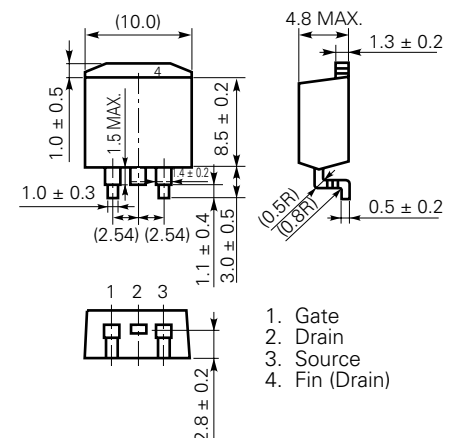
\*\* Starting  $T_{ch} = 25 \text{ }^\circ\text{C}$ ,  $R_G = 25 \Omega$ ,  $V_{GS} = 20 \text{ V} \rightarrow 0$

### PACKAGE DIMENSIONS

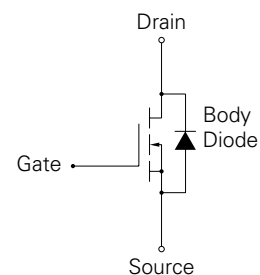
(in millimeters)



### MP-25 (TO-220)



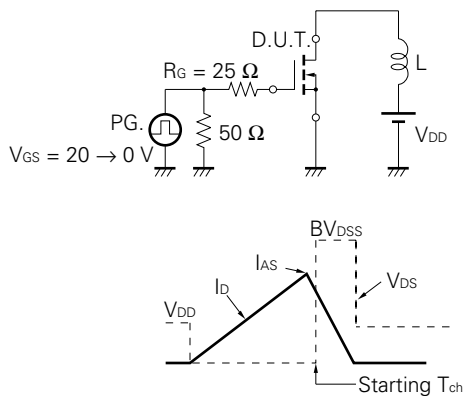
### MP-25Z (SURFACE MOUNT TYPE)



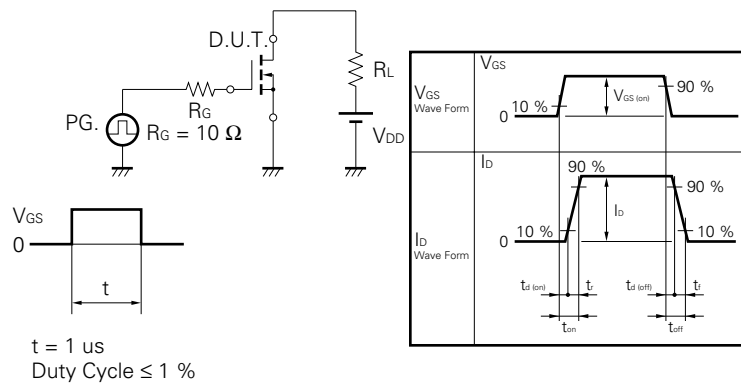
**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	R <sub>DS(on)</sub>		1.1	1.5	Ω	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.5 A
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	2.5		3.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	y <sub>fs</sub>	1.5			S	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.5 A
Drain Leakage Current	I <sub>DSS</sub>			100	μA	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0
Gate to Source Leakage Current	I <sub>GSS</sub>			±100	nA	V <sub>GS</sub> = ±30 V, V <sub>DS</sub> = 0
Input Capacitance	C <sub>iss</sub>		930		pF	V <sub>DS</sub> = 10 V
Output Capacitance	C <sub>oss</sub>		200		pF	V <sub>GS</sub> = 0
Reverse Transfer Capacitance	C <sub>rss</sub>		40		pF	f = 1 MHz
Turn-On Delay Time	t <sub>d(on)</sub>		20		ns	V <sub>GS</sub> = 10 V
Rise Time	t <sub>r</sub>		12		ns	V <sub>DD</sub> = 150 V
Turn-Off Delay Time	t <sub>d(off)</sub>		60		ns	I <sub>D</sub> = 3.5 A, R <sub>G</sub> = 10 Ω
Fall Time	t <sub>f</sub>		12		ns	R <sub>L</sub> = 42.9 Ω
Total Gate Charge	Q <sub>G</sub>		30		nC	V <sub>GS</sub> = 10 V
Gate to Source Charge	Q <sub>GS</sub>		6.0		nC	I <sub>D</sub> = 7.0 V
Gate to Drain Charge	Q <sub>GD</sub>		15		nC	V <sub>DD</sub> = 450 V
Diode Forward Voltage	V <sub>F(S-D)</sub>		1.0		V	I <sub>F</sub> = 7.0 A, V <sub>GS</sub> = 0
Reverse Recovery Time	t <sub>rr</sub>		400		ns	I <sub>F</sub> = 7.0 A
Reverse Recovery Charge	Q <sub>rr</sub>		2.0		μC	di/dt = 50 A/μs

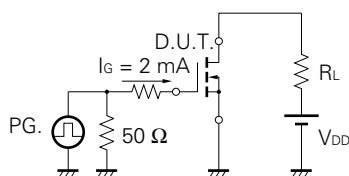
**Test Circuit 1 Avalanche Capability**



**Test Circuit 2 Switching Time**

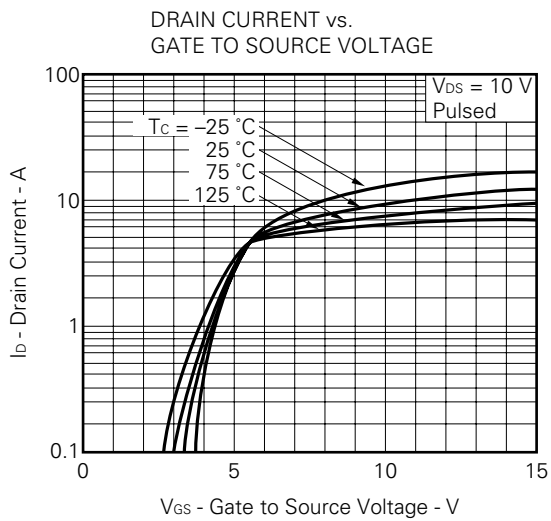
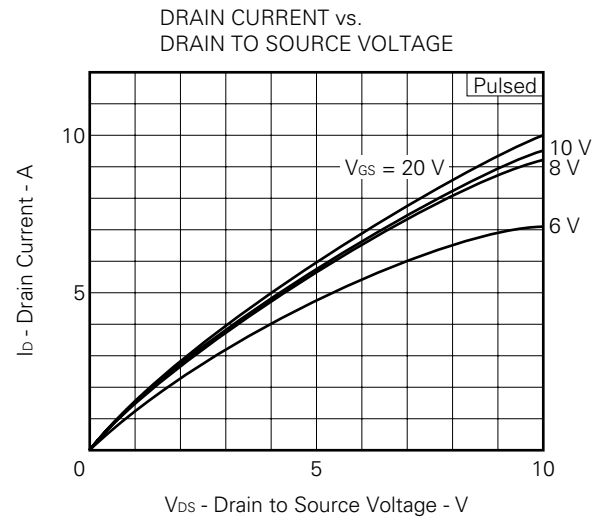
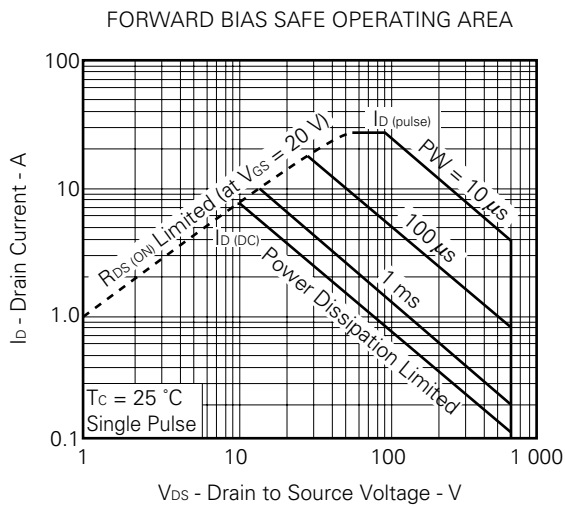
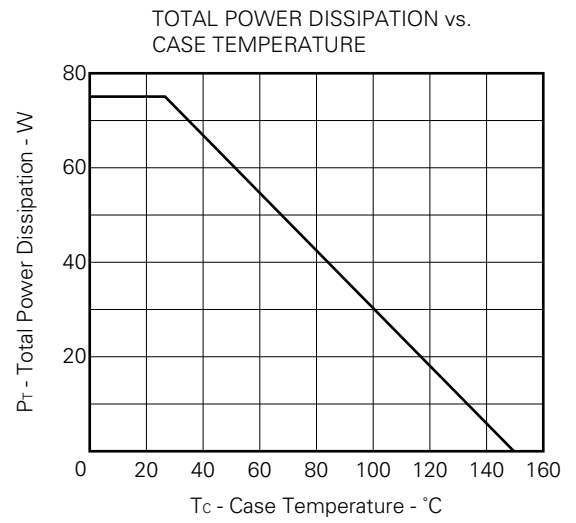
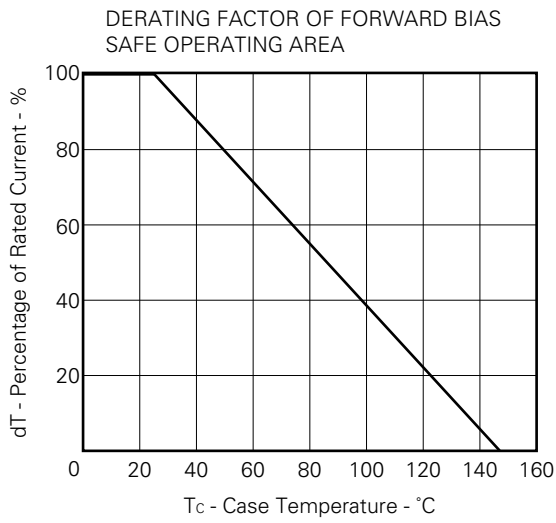


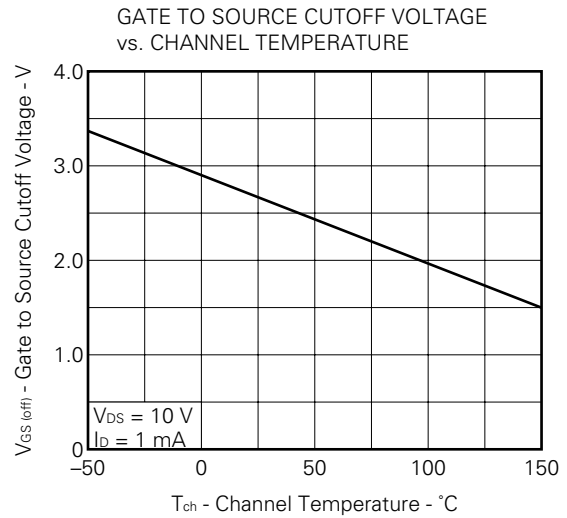
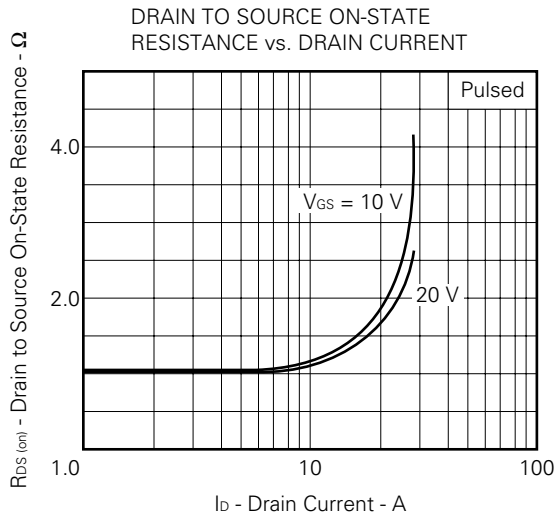
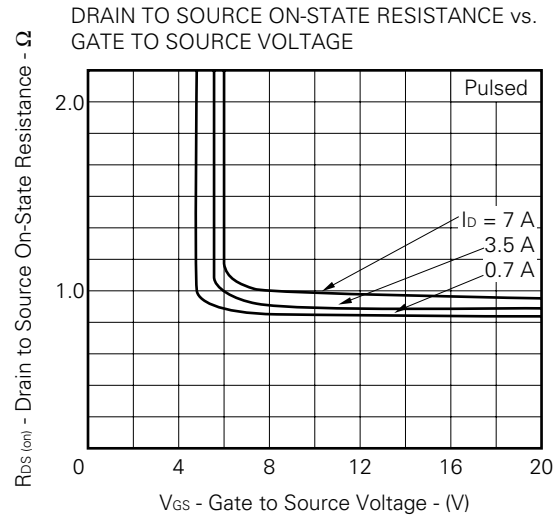
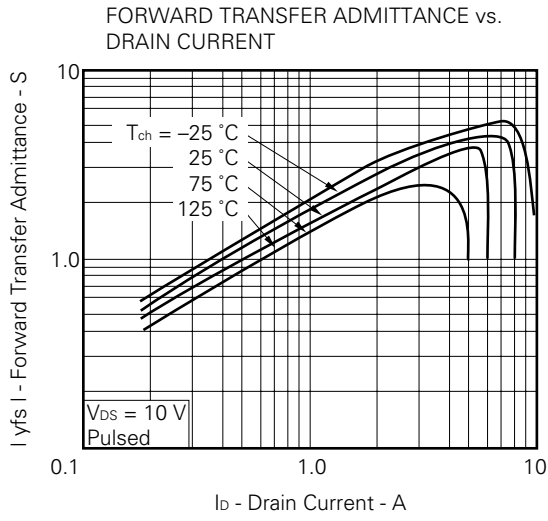
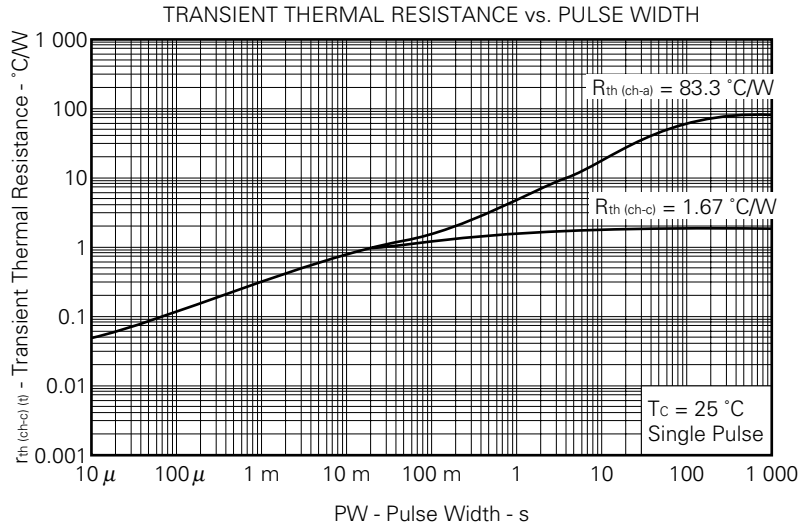
**Test Circuit 3 Gate Charge**

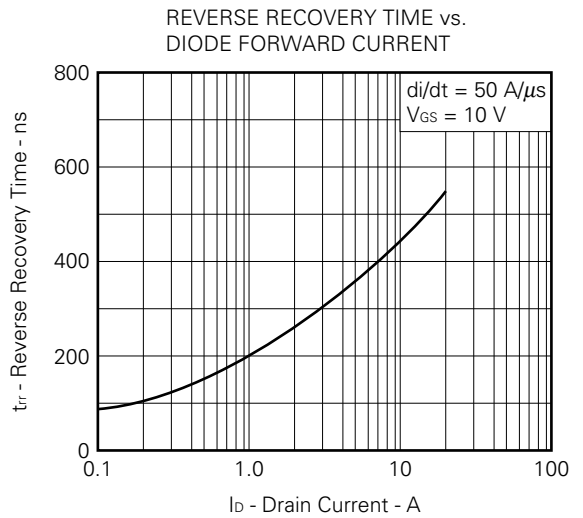
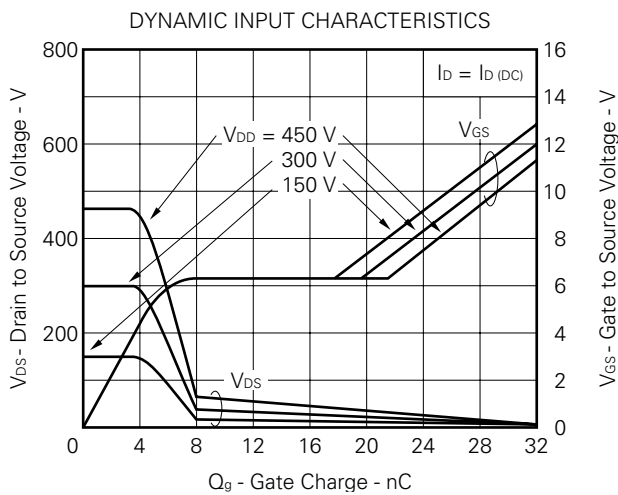
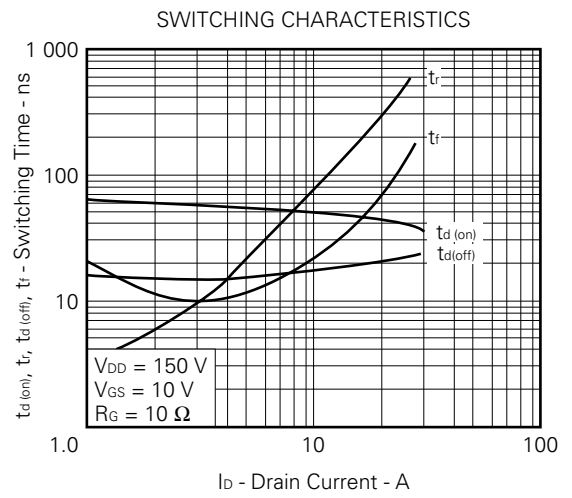
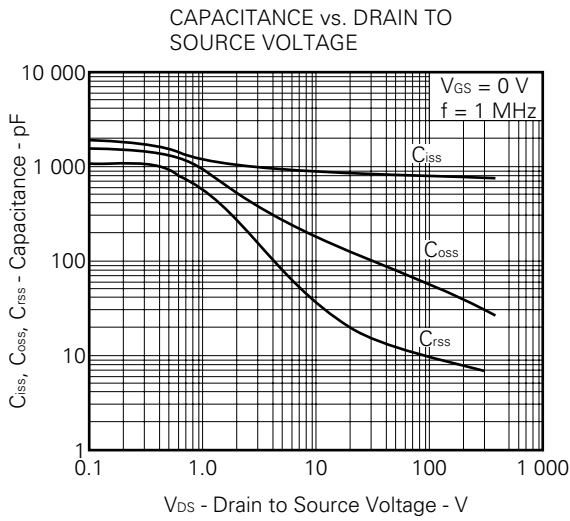
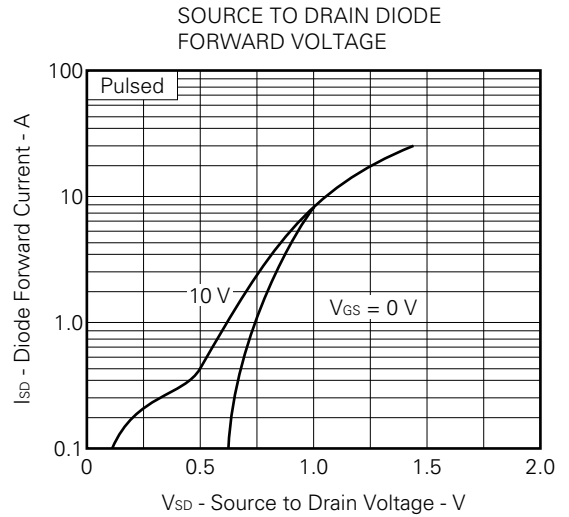
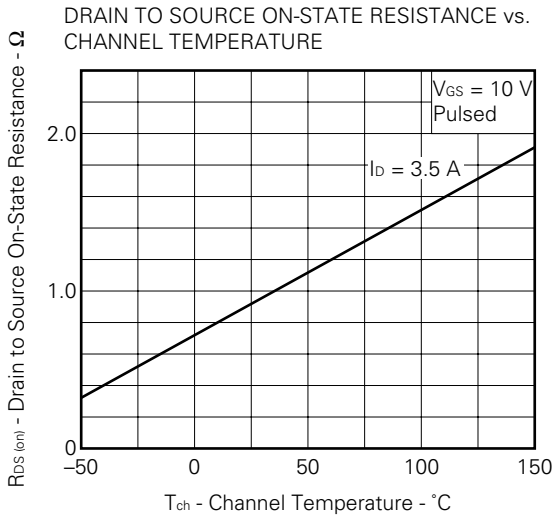


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

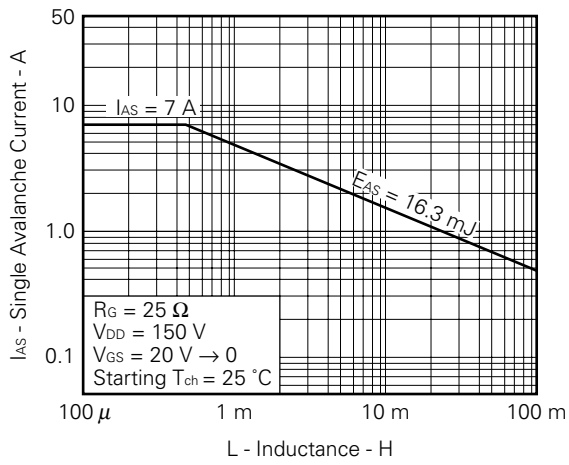
TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)







SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE

